

January 1993 Revised November 1999

74ABT373

Octal Transparent Latch with 3-STATE Outputs

General Description

The ABT373 consists of eight latches with 3-STATE outputs for bus organized system applications. The flip-flops appear transparent to the data when Latch Enable (LE) is HIGH. When LE is LOW, the data that meets the setup times is latched. Data appears on the bus when the Output Enable ($\overline{\text{OE}}$) is LOW. When $\overline{\text{OE}}$ is HIGH the bus output is in the high impedance state.

Features

- 3-STATE outputs for bus interfacing
- Output sink capability of 64 mA, source capability of 32 mA
- Guaranteed output skew
- Guaranteed multiple output switching specifications
- Output switching specified for both 50 pF and 250 pF
- Guaranteed simultaneous switching, noise level and dynamic threshold performance
- Guaranteed latchup protection
- High impedance glitch free bus loading during entire power up and power down
- Nondestructive hot insertion capability

Ordering Code:

Order Number	Package Number	Package Description
74ABT373CSC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Body
74ABT373CSJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74ABT373CMSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
74ABT373CMTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74ABT373CPC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0,300" Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Connection Diagram



Pin Descriptions

Pin Names	Description
D ₀ -D ₇	Data Inputs
LE	Latch Enable Input (Active HIGH)
OE	Output Enable Input (Active LOW)
O ₀ –O ₇	3-STATE Latch Outputs

Functional Description

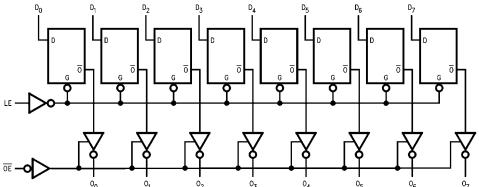
The ABT373 contains eight D-type latches with 3-STATE output buffers. When the Latch Enable (LE) input is HIGH, data on the $\mathbf{D}_{\mathbf{n}}$ inputs enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time its D input changes. When LE is LOW, the latches store the information that was present on the D inputs at setup time preceding the HIGH-to-LOW transition of LE. The 3-STATE buffers are controlled by the Output Enable (OE) input. When OE is LOW, the buffers are in the bi-state mode. When $\overline{\text{OE}}$ is HIGH the buffers are in the high impedance mode but this does not interfere with entering new data into the latches.

Truth Table

	Inputs	Output	
LE	OE	D _n	O _n
Н	L	Н	Н
Н	L	L	L
L	L	Х	O _n (no change)
Χ	Н	Х	Z

- H = HIGH Voltage Level
- L = LOW Voltage Level
- X = Immaterial Z = HIGH Impedance State

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings(Note 1)

Recommended Operating Conditions

-65°C to +150°C Storage Temperature

-55°C to +125°C Ambient Temperature under Bias

Junction Temperature under Bias -55°C to +150°C

V_{CC} Pin Potential to Ground Pin

-0.5V to +7.0VInput Voltage (Note 2) -0.5V to +7.0VInput Current (Note 2) -30 mA to +5.0 mA

Voltage Applied to Any Output

in the Disabled or

Power-Off State -0.5V to +5.5Vin the HIGH State -0.5V to V_{CC}

Current Applied to Output

in LOW State (Max) DC Latchup Source Current: OE Pin -150 mA

(Across Comm Operating Range)

Over Voltage Latchup (I/O)

Free Air Ambient Temperature -40°C to +85°C Supply Voltage +4.5V to +5.5

Minimum Input Edge Rate ($\Delta V/\Delta t$)

50 mV/ns Data Input Enable Input 20 mV/ns

twice the rated I_{OL} (mA)

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Other Pins -500 mA Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parame	eter	Min	Тур	Max	Units	v _{cc}	Conditions
V _{IH}	Input HIGH Voltage		2.0			V		Recognized HIGH Signal
V _{IL}	Input LOW Voltage				8.0	V		Recognized LOW Signal
V _{CD}	Input Clamp Diode Vol	tage			-1.2	V	Min	I _{IN} = −18 mA
V _{OH}	Output HIGH Voltage		2.5			V	Min	$I_{OH} = -3 \text{ mA}$
			2.0			V	IVIIII	$I_{OH} = -32 \text{ mA}$
V _{OL}	Output LOW Voltage				0.55	V	Min	I _{OL} = 64 mA
I _{IH}	Input HIGH Current				1	μА	Max	V _{IN} = 2.7V (Note 4)
					1	μΑ	IVIAX	$V_{IN} = V_{CC}$
I _{BVI}	Input HIGH Current Br	eakdown Test			7	μΑ	Max	V _{IN} = 7.0V
I _{IL}	Input LOW Current				-1	μА	Max	V _{IN} = 0.5V (Note 4)
					-1	μА	IVIAX	$V_{IN} = 0.0V$
V _{ID}	Input Leakage Test		4.75			V	0.0	$I_{ID} = 1.9 \mu A$
								All Other Pins Grounded
I _{OZH}	Output Leakage Curre	nt			10	μΑ	0 – 5.5V	V _{OUT} = 2.7V; OE = 2.0V
I _{OZL}	Output Leakage Curre	nt			-10	μΑ	0 – 5.5V	V _{OUT} = 0.5V; OE = 2.0V
Ios	Output Short-Circuit C	urrent	-100		-275	mA	Max	V _{OUT} = 0.0V
I _{CEX}	Output High Leakage	Current			50	μΑ	Max	$V_{OUT} = V_{CC}$
I _{ZZ}	Bus Drainage Test				100	μΑ	0.0	V _{OUT} = 5.5V; All Others GND
I _{CCH}	Power Supply Current				50	μΑ	Max	All Outputs HIGH
I _{CCL}	Power Supply Current				30	mA	Max	All Outputs LOW
I _{CCZ}	Power Supply Current				50	μΑ	Max	OE = V _{CC}
								All Others at V _{CC} or GND
I _{CCT}	Additional I _{CC} /Input	Outputs Enabled			2.5	mA		$V_I = V_{CC} - 2.1V$
		Outputs 3-STATE			2.5	mA	Max	Enable Input V _I = V _{CC} - 2.1V
		Outputs 3-STATE			2.5	mA		Data Input V _I = V _{CC} - 2.1V
								All Others at V _{CC} or GND
I _{CCD}	Dynamic I _{CC}	No Load	-	-		mA/	May	Outputs Open, LE = V _{CC}
	(Note 4)				0.12	MHz	Max	OE = GND, (Note 3)
								One Bit Toggling, 50% Duty Cycle

Note 3: For 8 bits toggling, $I_{CCD} < 0.8 \text{ mA/MHz}$.

Note 4: Guaranteed, but not tested.

DC Electrical Characteristics

(SOIC Package)

Symbol	Parameter	Min	Тур	Max	Units	V _{CC}	Conditions $C_L = 50 \text{ pF}, R_L = 500\Omega$
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}		0.4	8.0	V	5.0	T _A = 25°C (Note 5)
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	-1.2	-0.8		V	5.0	T _A = 25°C (Note 5)
V _{OHV}	Minimum HIGH Level Dynamic Output Voltage	2.5	3.0		V	5.0	T _A = 25°C (Note 6)
V_{IHD}	Minimum HIGH Level Dynamic Input Voltage	2.0	1.7		V	5.0	T _A = 25°C (Note 7)
V _{ILD}	Maximum LOW Level Dynamic Input Voltage		0.9	0.6	V	5.0	T _A = 25°C (Note 7)

Note 5: Max number of outputs defined as (n). n – 1 data inputs are driven 0V to 3V. One output at Low. Guaranteed, but not tested.

Note 6: Max number of outputs defined as (n). n - 1 data inputs are driven 0V to 3V. One output HIGH. Guaranteed, but not tested.

Note 7: Max number of data inputs (n) switching. n – 1 inputs switching 0V to 3V. Input-under-test switching: 3V to threshold (V_{ILD}), 0V to threshold (V_{IHD}). Guaranteed, but not tested.

AC Electrical Characteristics

(SOIC and SSOP Packages)

Symbol	Parameter	$T_A = +25$ °C $V_{CC} = +5.0$ V $C_L = 50 \text{ pF}$		$T_A = -55^{\circ}\text{C to } +125^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_L = 50 \text{ pF}$		$T_A = -40$ °C to +85°C $V_{CC} = 4.5$ V to 5.5V $C_L = 50$ pF		Units	
		Min	Тур	Max	Min	Max	Min	Max	
t _{PLH}	Propagation Delay	1.9	2.7	4.5	1.0	6.8	1.9	4.5	
t _{PHL}	D _n to O _n	1.9	2.8	4.5	1.0	7.0	1.9	4.5	ns
t _{PLH}	Propagation Delay	2.0	3.1	5.0	1.0	7.7	2.0	5.0	
t _{PHL}	LE to O _n	2.0	3.0	5.0	1.5	7.7	2.0	5.0	ns
t _{PZH}	Output Enable Time	1.5	3.1	5.3	1.0	6.7	1.5	5.3	
t_{PZL}		1.5	3.1	5.3	1.5	7.2	1.5	5.3	ns
t _{PHZ}	Output Disable Time	2.0	3.6	5.4	1.7	8.0	2.0	5.4	20
t _{PLZ}		2.0	3.4	5.4	1.0	7.0	2.0	5.4	ns

AC Operating Requirements

(SOIC and SSOP Packages)

Symbol Parameter		$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$		$T_A = -55^{\circ}\text{C to } +125^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_L = 50 \text{ pF}$		$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_L = 50 \text{ pF}$		Units	
		Min	Тур	Max	Min	Max	Min	Max	
f _{TOGGLE}	Max Toggle Frequency		100		100				MHz
t _S (H)	Setup Time, HIGH	1.5			2.5		1.5		20
t _S (L)	or LOW D _n to LE	1.5			2.5		1.5		ns
t _H (H)	Hold Time, HIGH	1.0			2.5		1.0		20
t _H (L)	or LOW D _n to LE	1.0			2.5		1.0		ns
t _W (H)	Pulse Width, LE HIGH	3.0			3.3		3.0		ns

Extended AC Electrical Characteristics

(SOIC Package)

Symbol	Parameter	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_L = 50 \text{ pF}$ 8 Outputs Switching (Note 8)		$T_{A} = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_{L} = 250 \text{ pF}$ (Note 9)		$T_{A} = -40^{\circ}\text{C to} +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_{L} = 250 \text{ pF}$ 8 Outputs Switching (Note 10)		Units
		Min	Max	Min	Max	Min	Max	
t _{PLH}	Propagation Delay	1.5	5.2	2.0	6.8	2.0	9.0	ns
t _{PHL}	D _n to O _n	1.5	5.2	2.0	6.8	2.0	9.0	115
t _{PLH}	Propagation Delay	1.5	5.5	2.0	7.5	2.0	9.5	ns
t _{PHL}	LE to O _n	1.5	5.5	2.0	7.5	2.0	9.5	115
t _{PZH}	Output Enable Time	1.5	6.2	2.0	8.0	2.0	10.5	
t _{PZL}		1.5	6.2	2.0	8.0	2.0	10.5	ns
t _{PHZ}	Output Disable Time	1.0	5.5	(Note 11)		(Note 11)		ns
t _{PZL}		1.0	5.5					

Note 8: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.).

Note 9: This specification is guaranteed but not tested. The limits represent propagation delay with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load. This specification pertains to single output switching only.

Note 10: This specification is guaranteed but not tested. The limits represent propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.) with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load.

Note 11: The 3-STATE delay times are dominated by the RC network (500 Ω , 250 pF) on the output and has been excluded from the datasheet.

Skew

(SOIC Package)

Symbol	Parameter	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V} - 5.5\text{V}$ $C_L = 50 \text{ pF}$ 8 Outputs Switching (Note 12)	$T_A = -40$ °C to +85 °C $V_{CC} = 4.5V - 5.5V$ $C_L = 250$ pF 8 Outputs Switching (Note 13)	Units
t _{OSHL} (Note 14)	Pin to Pin Skew, HL Transitions	1.0	1.5	ns
t _{OSLH} (Note 14)	Pin to Pin Skew, LH Transitions	1.0	1.5	ns
t _{PS} (Note 16)	Duty Cycle, LH-HL Skew	1.4	3.5	ns
t _{OST} (Note 14)	Pin to Pin Skew, LH/HL Transitions	1.5	3.9	ns
t _{PV} (Note 15)	Device to Device Skew, LH/HL Transitions	2.0	4.0	ns

Note 12: This specification is guaranteed but not tested. The limits represent propagation delays with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load.

Note 13: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.).

Note 14: Skew is defined as the absolute value of the difference between the actual propagation delays for any two separate outputs of the same device. The specification applies to any outputs switching HIGH-to-LOW (t_{OSHL}), LOW-to-HIGH (t_{OSLH}), or any combination switching LOW-to-HIGH and/or HIGH-to-LOW (t_{OST}). This specification is guaranteed but not tested.

Note 15: Propagation delay variation is for a given set of conditions (i.e., temperature and V_{CC}) from device to device. This specification is guaranteed but not tested

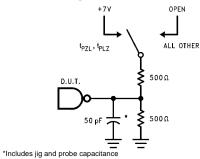
Note 16: This describes the difference between the delay of the LOW-to-HIGH and the HIGH-to-LOW transition on the same pin. It is measured across all the outputs (drivers) on the same chip, the worst (largest delta) number is the guaranteed specification. This specification is guaranteed but not tested.

Capacitance

Symbol	Parameter	Тур	Units	Conditions (T _A = 25°C)
C _{IN}	Input Capacitance	5	pF	$V_{CC} = 0V$
C _{OUT} (Note 17)	Output Capacitance	9	pF	$V_{CC} = 5.0V$

 $\textbf{Note 17: } \textbf{C}_{OUT} \textbf{ is measured at frequency } \textbf{f} = \textbf{1} \textbf{ MHz}, \textbf{per MIL-STD-883}, \textbf{Method 3012}.$

AC Loading



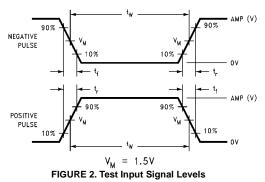


FIGURE 1. Standard AC Test Load

Amplitude	Rep. Rate	t _w	t _r	t _f	
3.0V	1 MHz	500 ns	2.5 ns	2.5 ns	

FIGURE 3. Test Input Signal Requirements

AC Waveforms

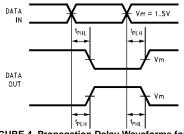
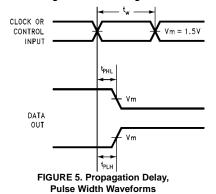
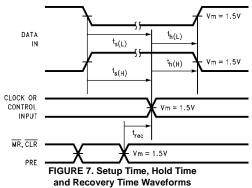


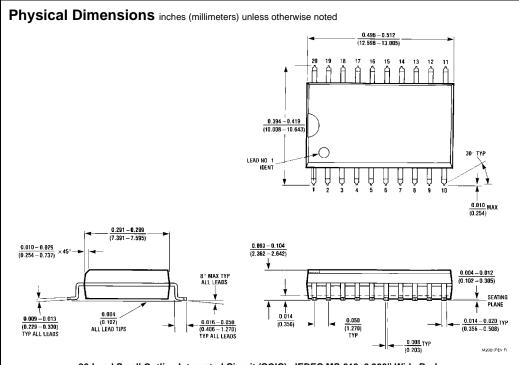
FIGURE 4. Propagation Delay Waveforms for Inverting and Non-Inverting Functions



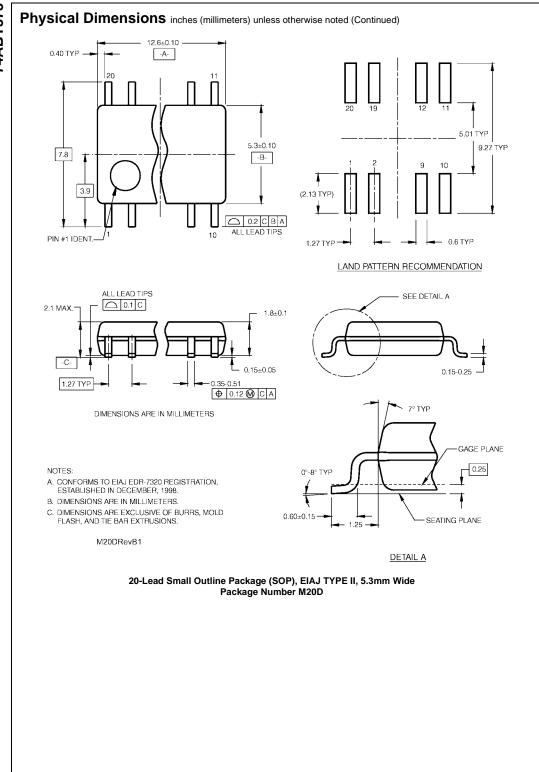
OUTPUT Vm = 1.5V CONTROL V_{OH} DATA OUT ₽ZL DATA OUT

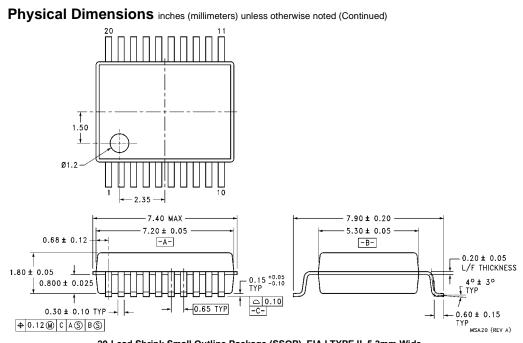
FIGURE 6. 3-STATE Output HIGH and LOW Enable and Disable Times



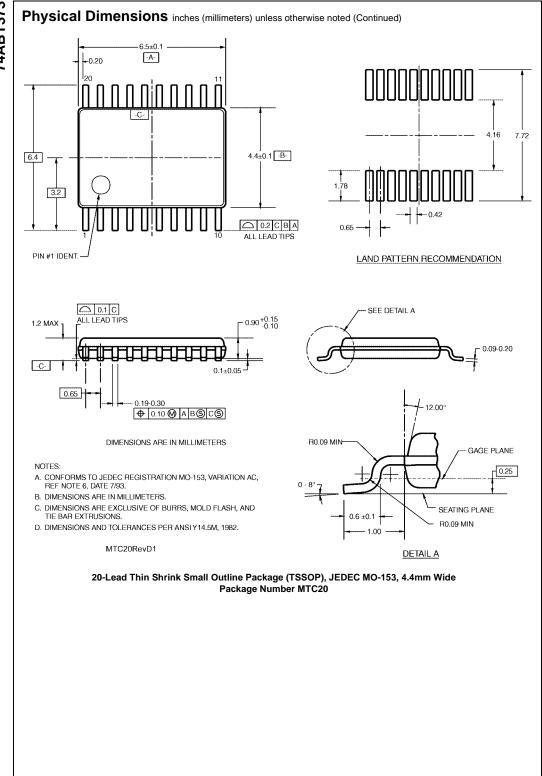


20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Body Package Number M20B

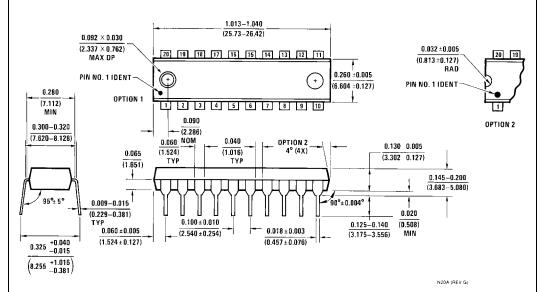




20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide Package Number MSA20



Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N20A

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